

2.0x1.25mm SMD CHIP LED LAMP

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: APT2012LSECK/J3-PRV Hyper Red

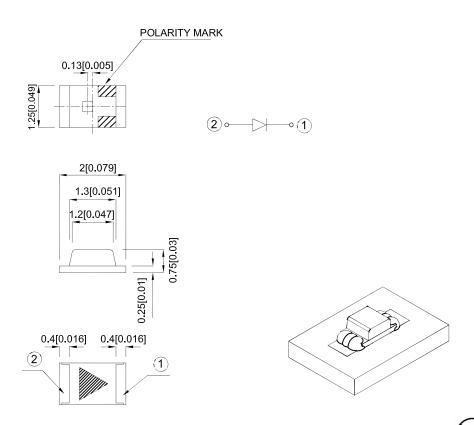
Features

- 2.0mmx1.25mm SMD LED,0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=2mA operating.
- RoHS compliant.

Descriptions

- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipment and machinery must be electri cally grounded.

Package Dimensions



SPEC NO: DSAN8393

APPROVED: Wynec

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.3A DATE: JAN/06/2017 PAGE: 1 OF 5 **CHECKED: Allen Liu** DRAWN: L.T.Zhang ERP: 1203014460



Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
			Min.	Тур.	201/2
APT2012LSECK/J3-PRV	Hyper Red (AlGaInP)	Water Clear	50	100	- 140°
			*20	*40	

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

 2. Luminous intensity/ luminous Flux: +/-15%.

 *Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red		640		nm	IF=2mA
λD [1]	Dominant Wavelength	Hyper Red		625		nm	IF=2mA
Δλ1/2	Spectral Line Half-width	Hyper Red		20		nm	IF=2mA
С	Capacitance	Hyper Red		27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	1.5	1.8	2.1	V	IF=2mA
lr	Reverse Current	Hyper Red			10	uA	V _R =5V

Notes:

- 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

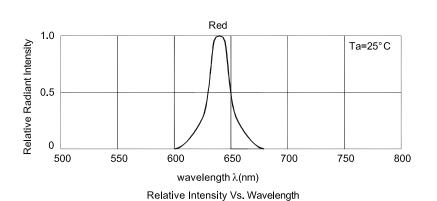
Parameter	Values				
Power dissipation	63	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C	-40°C To +85°C			

Notes:

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

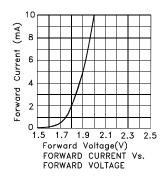
SPEC NO: DSAN8393 DATE: JAN/06/2017 PAGE: 2 OF 5 **REV NO: V.3A** APPROVED: Wynec **CHECKED: Allen Liu** DRAWN: L.T.Zhang ERP: 1203014460

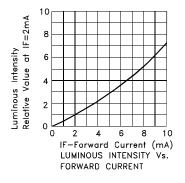
Kingbright

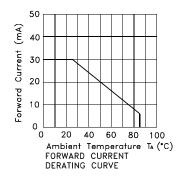


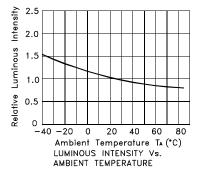
Hyper Red

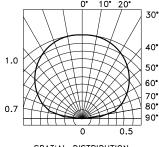
APT2012LSECK/J3-PRV











SPATIAL DISTRIBUTION

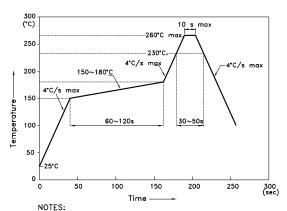
SPEC NO: DSAN8393 APPROVED: Wynec REV NO: V.3A CHECKED: Allen Liu DATE: JAN/06/2017 DRAWN: L.T.Zhang PAGE: 3 OF 5 ERP: 1203014460

Kingbright

APT2012LSECK/J3-PRV

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



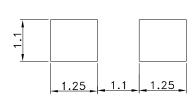
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

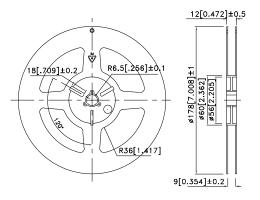
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

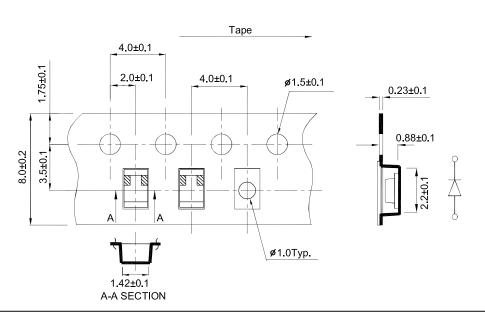
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)



SPEC NO: DSAN8393 **APPROVED: Wynec**

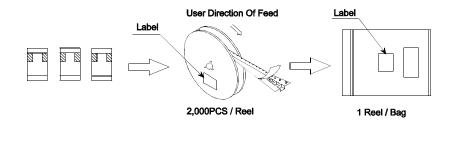
REV NO: V.3A CHECKED: Allen Liu

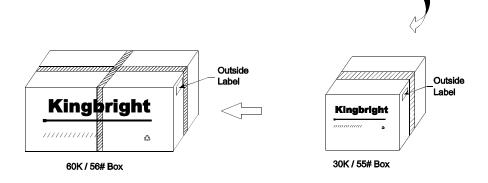
DATE: JAN/06/2017 DRAWN: L.T.Zhang PAGE: 4 OF 5 ERP: 1203014460

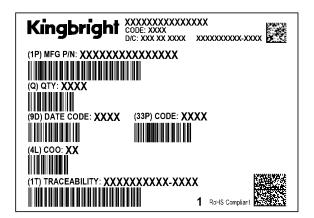
Kingbright

PACKING & LABEL SPECIFICATIONS

APT2012LSECK/J3-PRV







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

SPEC NO: DSAN8393 REV NO: V.3A DATE: JAN/06/2017 PAGE: 5 OF 5
APPROVED: Wynec CHECKED: Allen Liu DRAWN: L.T.Zhang ERP: 1203014460